

SPECIFICATION

Part No. : **RECE.20369.001E.01**

Product Name : IPEX MHFIII Receptacle Compatible with Hirose W.FL Mating Height: 1.6mm MAX 5,000 pieces per reel

Photo :





1. Introduction

The Taoglas RECE.20369.001E.01 is a wire-to-board MHFIII SMT type Receptacle solution that is ultra small, lightweight and low profile (1.5mm MAX.) with an operational frequency range of DC to 6 GHz. Taoglas RECE.20369.001E.01 is gold plated to give superior performance and allow easy mounting of the male RF connector. Packaged on tape and reel, this receptacle is designed to be placed with automatic "pick and place" equipment.

The RECE.20369.001E.01 acts as a 50 Ohm transmission line to connect the micro-miniature RF connector to the printed circuit board. It if fully compatible with MHFIII and Hirose W.FL connector.

Applicable Technology

In the field of application that requiring high frequency transmission using small coaxial connectors: GSM/GPS modules, IEEE 02.11 a/b/g/n, WiMAX, ZigBee, Bluetooth, MIMO, WiGig, etc,



2. Specifications

Electrical		
Operation Frequency	DC to 6 GHz	
VSWR	1.3 Max at DC~3 GHz	
	1.45 Max at 3~6 GHz	
Nominal Impedance	50 Ohm	
Rated Voltage	AC 60V	
Contact Resistance	20m Ohm MAX. (signal) and 20m Ohm MAX. (Ground)	
Withstand Voltage	AC 200V/minute	
Insulation Resistance	500M Ohm MIN. /DC 100V	

Material		
Outer Contact	Copper Alloy (Au plating)	
Center Contact	Copper Alloy (Au plating)	
Insulator	LCP UL94V-0	

Environmental		
Temperature	-40 to +90°C	
RoHs Complaint	Yes	
Halogen-Free	Yes	
Vibration (Mating connector)	Frequency: 10Hz-100Hz Duration: 20mins Peak value of acceleration: 59m/s ² (6G) Direction, cycle: 3 axis, 3 cycles	
Shock (Mating connector)	Peak Value of acceleration: 735m/s ² (75G) Duration: 11ms Waveform: Half sinusoidal Direction: 6 axis Cycles: 3 cycles for each direction	
Humidity	Temperature: 40+/- 2°C Humidity: 90~95%RH Duration 96 hours	
Thermal Shock	-55°C for 30mins to 85°C for 30mins Transition Time: 5 minutes Cycles: 5	
High temperature life	90+/- 2°C for 96 hours	
H ₂ S gas	Temperature: 40+/-2°C Relative Humidity: 80+/-5%RH Gas H ₂ S 3+/-1ppm	



Duration 96 hours

Temperature: 35+/-2°C Relative Humidity: 95~98%RH Salt Water Density: 5+/-1% (by weight) Duration: 48 Hours

Salt Water Spray



Bottom

3. Technical Drawing





Mated View





4. Footprint

PCB Footprint

<u>2.6^{±0.05}</u> <u>1.4^{±0.05}</u> <u>0.5^{±0.05}</u> <u>0.5^{±0.05}</u> <u>0.12^{±0.05AR}</u> <u>0.5^{±0.05}</u> <u>50Ohm CPW</u> PCB Thickness 0.4mm

Note:

1.Soldered Area.



5. Reflow Profile



Recommended soldering temperature profile